

STD95P3LLH6AG

Automotive-grade P-channel -30 V, 5 mΩ typ., -80 A STripFET™ H6 Power MOSFET in a DPAK package

Datasheet - production data

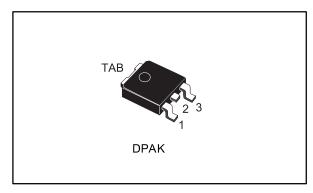
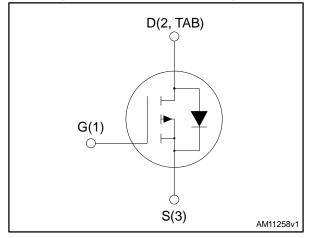


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	I _D	Ртот
STD95P3LLH6AG	-30 V	6.9 mΩ	-80 A	104 W

- Designed for automotive applications and AEC-Q101 qualified
- Very low on-resistance
- Very low gate charge
- High avalanche ruggedness
- Low gate drive power loss
- Logic level

Applications

Switching applications

Description

This device is a P-channel Power MOSFET developed using the STripFET $^{\text{TM}}$ H6 technology with a new trench gate structure. The resulting Power MOSFET exhibits very low $R_{\text{DS(on)}}$ in all packages.

Table 1: Device summary

Order code	Marking	Package	Packing
STD95P3LLH6AG	95P3LLH6	DPAK	Tape and reel

Contents STD95P3LLH6AG

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STD95P3LLH6AG Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage	-30	V
V_{GS}	Gate-source voltage	±18	V
Ip ⁽¹⁾	Drain current (continuous) at T _{case} = 25 °C	-80	Α
ID ^(*)	Drain current (continuous) at T _{case} = 100 °C	-80	Α
I _{DM} ⁽²⁾	Drain current (pulsed)	-320	Α
Ртот	Total dissipation at T _{case} = 25 °C	104	W
E _{AS} (3)	Single pulse avalanche energy	650	mJ
T _{stg}	Storage temperature range	55 to 150	°C
Tj	Operating junction temperature range		

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	1.2	900
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb	50	°C/W

Notes:

⁽¹⁾Limited by wire bonding

 $^{^{\}left(2\right) }$ Pulse width is limited by safe operating area.

 $^{^{(3)}}$ starting T_j = 25 °C, I_{AS} =-40 A, V_{DD} = -25 V

 $^{^{(1)}}$ When mounted on a 1-inch² FR-4, 2 Oz copper board

Electrical characteristics STD95P3LLH6AG

2 Electrical characteristics

(T_{case} = 25 °C unless otherwise specified)

Table 4: Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = -1 \text{ mA}$	-30			V
	Zara gata valtaga drain	$V_{GS} = 0 \text{ V}, V_{DS} = -30 \text{ V}$			-1	
IDSS	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = -30 \text{ V},$ $T_{case} = 125 \text{ °C}^{(1)}$			-10	μΑ
I _{GSS}	Gate-body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 18 \text{ V}$			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = -250 \mu A$	-1		-2.5	V
Static drain-source on-		$V_{GS} = -10 \text{ V}, I_D = -40 \text{ A}$		5	6.9	2
R _{DS(on)}	resistance	V _{GS} = -4.5 V, I _D = -40 A		7.5	9.7	mΩ

Notes:

Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	6250	-	
Coss	Output capacitance	V _{DS} = -25 V, f = 1 MHz,	-	830	ı	pF
Crss	Reverse transfer capacitance	$V_{GS} = 0 V$	-	590	-	ρ.
Q_g	Total gate charge	V _{DD} = -15 V, I _D = -80 A,	-	113	ı	
Q_{gs}	Gate-source charge	V _{GS} = -10 V (see <i>Figure 14</i> :	-	18.5	ı	nC
Q_{gd}	Gate-drain charge	"Gate charge test circuit")	-	19	-	

Table 6: Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = -15 \text{ V}, I_{D} = -80 \text{ A},$	ı	15	ı	
t _r	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = -10 V$ (see	1	30	•	
t _{d(off)}	Turn-off delay time	Figure 13: "Switching times	-	110	-	ns
t _f	Fall time	test circuit for resistive load")	-	70	-	

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 $[\]ensuremath{^{(1)}}\mbox{Defined}$ by design, not subject to production test.

Table 7: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		-80	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		-320	Α
V _{SD} ⁽²⁾	Forward on voltage	V _G S = 0 V, I _{SD} = -80 A	-		-1.5	V
t _{rr}	Reverse recovery time		-	27		ns
Qrr	Reverse recovery charge	I _{SD} = -80 A, di/dt = 100 A/µs, V _{DD} = -24 V (see Figure 15: "Test circuit for inductive load switching	-	17		nC
I _{RRM}	Reverse recovery current	and diode recovery times")	-	-1.2		Α

Notes:

⁽¹⁾ Pulse width is limited by safe operating area.

 $^{^{(2)}}$ Pulse test: pulse duration = 300 $\mu s,$ duty cycle 1.5%.

2.1 Electrical characteristics (curves)

Figure 2: Safe operating area $\begin{array}{c|c} I_D & GADG270720160953SOA \\ \hline (A) & Operation in this area is \\ \hline 10^2 & t_p = 100 \mu s \\ \hline 10^1 & t_p = 10 m s \\ \hline T_i \leq 150 ~C \\ \hline T_i = 25 ~C \\ \hline 10^0 & 10^{-1} & 10^0 & 10^1 & V_{DS} (V) \\ \hline \end{array}$

Figure 3: Thermal impedance

K

δ=0.5

0.2

0.1

10⁻¹

Single pulse

10⁻²

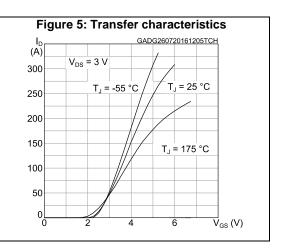
10⁻⁶

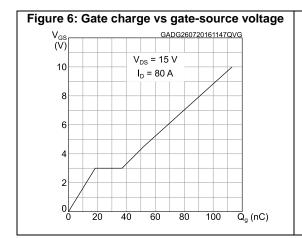
10⁻⁴

10⁻³

10⁻²

t_p (s)





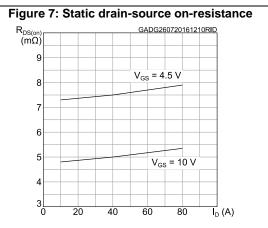


Figure 8: Capacitance variations

C

GADG260720161145CVR

(pF)

103

F = 1 MHz

Coss

CRSS

CRSS

CRSS

CRSS

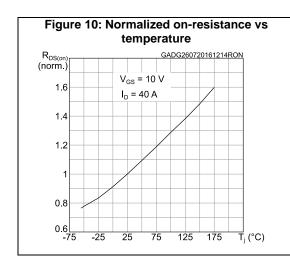
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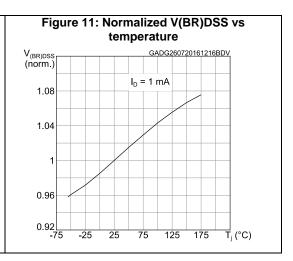
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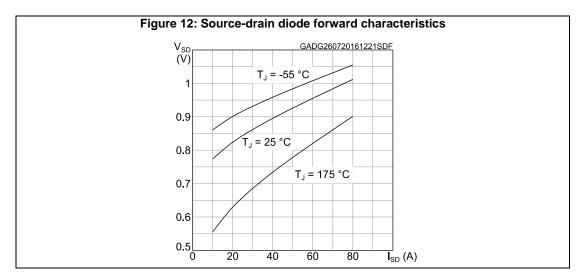
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CRSS

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For the P-channel Power MOSFET, current and voltage polarities are reversed.

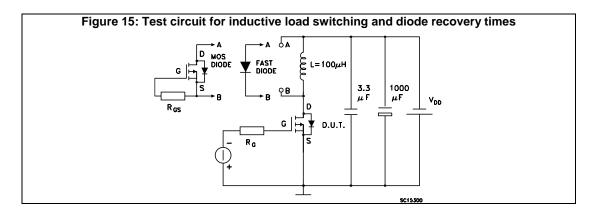
Test circuits STD95P3LLH6AG

3 Test circuits

Figure 13: Switching times test circuit for resistive load

Figure 14: Gate charge test circuit

Figure 14: Gate charge test circuit



4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

4.1 DPAK type A2 package information

Figure 16: DPAK (TO-252) type A2 package outline

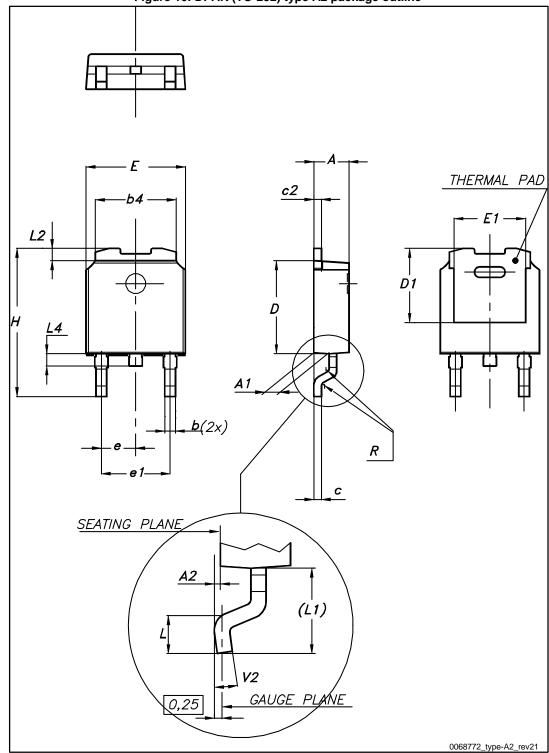
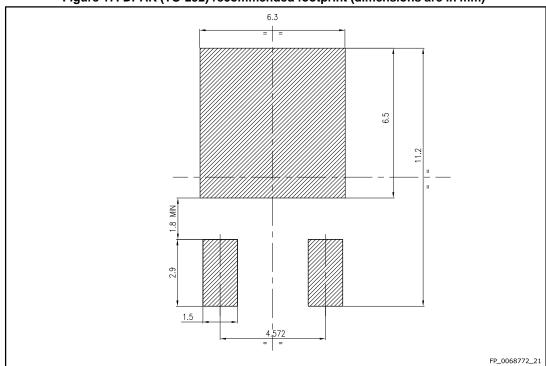


Table 8: DPAK (TO-252) type A2 mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
A	2.20		2.40
A1	0.90		1.10
A2	0.03		0.23
b	0.64		0.90
b4	5.20		5.40
С	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
D1	4.95	5.10	5.25
Е	6.40		6.60
E1	5.10	5.20	5.30
е	2.16	2.28	2.40
e1	4.40		4.60
Н	9.35		10.10
L	1.00		1.50
L1	2.60	2.80	3.00
L2	0.65	0.80	0.95
L4	0.60		1.00
R		0.20	
V2	0°		8°

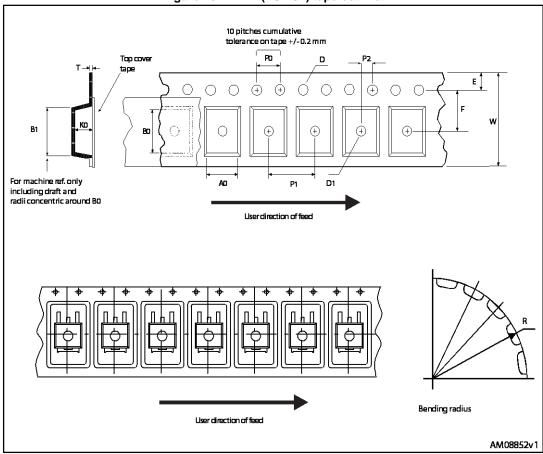
Package information STD95P3LLH6AG





4.2 DPAK packing information

Figure 18: DPAK (TO-252) tape outline



40mm min. access hole at slot location С Ν Α G measured Tape slot at hub in core for Full radius tape start 2.5mm min.width

Figure 19: DPAK (TO-252) reel outline

Table 9: DPAK (TO-252) tape and reel mechanical data

AM06038v1

	Таре	, , (. ,		Reel	
Dim	m	ım	Dim.	r	nm
Dim.	Min.	Max.	Diiii.	Min.	Max.
A0	6.8	7	А		330
В0	10.4	10.6	В	1.5	
B1		12.1	С	12.8	13.2
D	1.5	1.6	D	20.2	
D1	1.5		G	16.4	18.4
E	1.65	1.85	N	50	
F	7.4	7.6	Т		22.4
K0	2.55	2.75			
P0	3.9	4.1	Bas	e qty.	2500
P1	7.9	8.1	Bull	k qty.	2500
P2	1.9	2.1			
R	40				
Т	0.25	0.35			
W	15.7	16.3			

STD95P3LLH6AG Revision history

5 Revision history

Table 10: Document revision history

Date	Revision	Changes
26-Jul-2016	1	First release.

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